Special Issue

Machine Learning for Service Composition in Cloud Manufacturing

Message from the Guest Editors

This Special Issue aims to provide a platform for practitioners and researchers to discuss ML techniques' applications for managing cloud manufacturing activities for service composition. This Special Issue provides an opportunity to present the empirical evidence and technical strategies for proposing novel techniques, tools, frameworks, and standards to maximize the significance of ML techniques in cloud manufacturing. We welcome the article covering the ML applications study for service composite in cloud manufacturing. In this Special Issue, original research articles and reviews are welcome. Research areas may include (but not limited to) the following:

- Machine Learning applications for cloud manufacturing;
- Cloud service composition using metaheuristic services;
- Predictive model for cloud manufacturing;
- Composite service selection;
- Intelligent cloud service and machine learning;
- Cloud services composition using Machine Learning approaches;
- Automatic machine learning composition;
- Data science of cloud computing and Machine Learning;

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Deadline for manuscript submissions

closed (15 November 2023)

Electronics

an Open Access Journal by MDPI

Impact Factor 2.6
CiteScore 6.1

mdpi.com/si/134350

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Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

Editor-in-Chief

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